

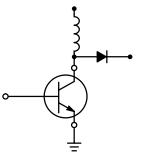
SWITCHMODE[™] **Series NPN Silicon Power Transistors**

The 2N6547 transistor is designed for high-voltage, high-speed, power switching in inductive circuits where fall time is critical. They are particularly suited for 115 and 220 volt line operated switch-mode applications such as:

- Switching Regulators
- PWM Inverters and Motor Controls
- Solenoid and Relay Drivers
- Deflection Circuits

Specification Features

High Temperature Performance Specified for:
 Reversed Biased SOA with Inductive Loads
 Switching Times with Inductive Loads
 Saturation Voltages
 Leakage Currents



2N6547

15 AMPERE
NPN SILICON
POWER TRANSISTORS
300 and 400 VOLTS
175 WATTS



CASE 1-07 TO-204AA (TO-3)

MAXIMUM RATINGS (1)

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V _{CEO(sus)}	400	Vdc
Collector–Emitter Voltage	V _{CEX(sus)}	450	Vdc
Collector–Emitter Voltage	V _{CEV}	850	Vdc
Emitter Base Voltage	V _{EB}	9.0	Vdc
Collector Current — Continuous — Peak (2)	I _C	15 30	Adc
Base Current — Continuous — Peak (2)	I _B	10 20	Adc
Emitter Current — Continuous — Peak (2)	I _E	25 35	Adc
Total Power Dissipation @ T _C = 25°C @ T _C = 100°C Derate above 25°C	P _D	175 100 1.0	Watts W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +200	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{ heta JC}$	1.0	°C/W
Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T _L	275	°C

*ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

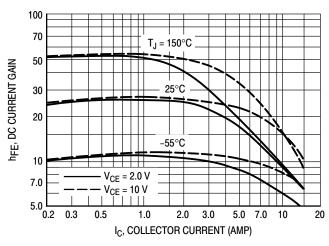
Characteristic		Symbol	Min	Max	Unit
DFF CHARACTERISTICS (1)					•
Collector–Emitter Sustaining Voltage ($I_C = 100 \text{ mA}, I_B = 0$)	2N6546 2N6547	V _{CEO(sus)}	300 400	_	Vdc
Collector–Emitter Sustaining Voltage ($I_C = 8.0 \text{ A}, V_{clamp} = \text{Rated } V_{CEX}, T_C = 100^{\circ}\text{C}$) ($I_C = 15 \text{ A}, V_{clamp} = \text{Rated } V_{CEO} = 100 \text{ V}, T_C = 100^{\circ}\text{C}$)	2N6546 2N6547 2N6546 2N6547	V _{CEX(sus)}	350 450 200 300	_ _ _ _	Vdc
Collector Cutoff Current $(V_{CEV} = Rated\ Value,\ V_{BE(off)} = 1.5\ Vdc)$ $(V_{CEV} = Rated\ Value,\ V_{BE(off)} = 1.5\ Vdc,\ T_C = 100^{\circ}C)$		I _{CEV}		1.0 4.0	mAdc
Collector Cutoff Current $(V_{CE} = Rated V_{CEV}, R_{BE} = 50 \Omega, T_{C} = 100^{\circ}C)$		I _{CER}	_	5.0	mAdc
Emitter Cutoff Current (V _{EB} = 9.0 Vdc, I _C = 0)		I _{EBO}	_	1.0	mAdc
SECOND BREAKDOWN				l	
Second Breakdown Collector Current with base forward biased $t = 1.0 \text{ s}$ (non–repetitive) ($V_{CE} = 100 \text{ Vdc}$)		I _{S/b}	0.2	_	Adc
ON CHARACTERISTICS (1)				l .	
DC Current Gain $ (I_C = 5.0 \text{ Adc}, V_{CE} = 2.0 \text{ Vdc}) $ $ (I_C = 10 \text{ Adc}, V_{CE} = 2.0 \text{ Vdc}) $		h _{FE}	1 2 6.0	60 30	_
Collector–Emitter Saturation Voltage ($I_C = 10$ Adc, $I_B = 2.0$ Adc) ($I_C = 15$ Adc, $I_B = 3.0$ Adc) ($I_C = 10$ Adc, $I_B = 2.0$ Adc, $I_C = 100^{\circ}$ C)		V _{CE(sat)}	_ _ _	1.5 5.0 2.5	Vdc
Base–Emitter Saturation Voltage (I_C = 10 Adc, I_B = 2.0 Adc) (I_C = 10 Adc, I_B = 2.0 Adc, T_C = 100°C		V _{BE(sat)}	_ _	1.6 1.6	Vdc
DYNAMIC CHARACTERISTICS					
Current–Gain — Bandwidth Product ($I_C = 500 \text{ mAdc}$, $V_{CE} = 10 \text{ Vdc}$, $f_{test} = 1.0 \text{ MHz}$)		f _T	6.0	28	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f _{test} = 1.0 MHz)		C _{ob}	125	500	pF

SWITCHING CHARACTERISTICS

Resistive Load					
Delay Time		t _d	_	0.05	μs
Rise Time	$(V_{CC} = 250 \text{ V}, I_C = 10 \text{ A},$	t _r	_	1.0	μs
Storage Time	$I_{B1} = I_{B2} = 2.0 \text{ A, t}_p = 100 \mu\text{s,}$ Duty Cycle $\leq 2.0\%$)	t _s	_	4.0	μs
Fall Time		t _f	_	0.7	μs
Inductive Load, Clamped					
Storage Time	$(I_C = 10 \text{ A(pk)}, V_{clamp} = \text{Rated } V_{CEX}, I_{B1} = 2.0 \text{ A},$	t _s	_	5.0	μs
Fall Time	$V_{BE(off)} = 5.0 \text{ Vdc}, T_{C} = 100^{\circ}\text{C})$	t _f	_	1.5	μs
			Тур	ical	
Storage Time	$(I_C = 10 \text{ A(pk)}, V_{clamp} = \text{Rated } V_{CEX}, I_{B1} = 2.0 \text{ A},$	t _s	2	.0	μs
Fall Time	$V_{BE(off)} = 5.0 \text{ Vdc}, T_C = 25^{\circ}C)$	t _f	0.09		μs

^{*}Indicates JEDEC Registered Data.
(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle = 2%.

TYPICAL ELECTRICAL CHARACTERISTICS

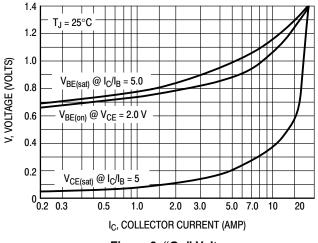


V_{CE}, COLLECTOR-EMITTER VOLTAGE (VOLTS) 1.6 $I_C = 2.0 A$ 1.2 5.0 A 10 A 15 A 8.0 0.4 0.07 0.1 0.2 0.3 0.5 0.7 1.0 2.0 3.0 5.0 7.0 IB, COLLECTOR CURRENT (AMP)

 $T_J = 25^{\circ}C$

Figure 1. DC Current Gain

Figure 2. Collector Saturation Region



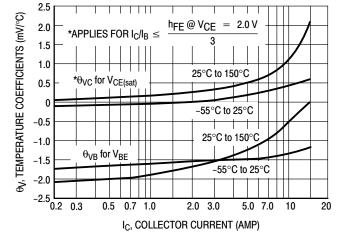
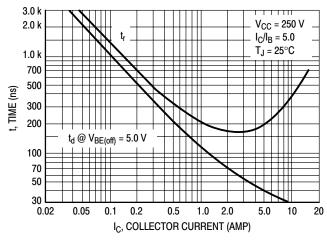


Figure 3. "On" Voltages

Figure 4. Temperature Coefficients



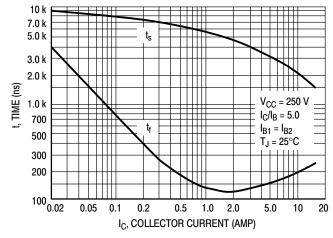


Figure 5. Turn-On Time

Figure 6. Turn-Off Time

MAXIMUM RATED SAFE OPERATING AREAS

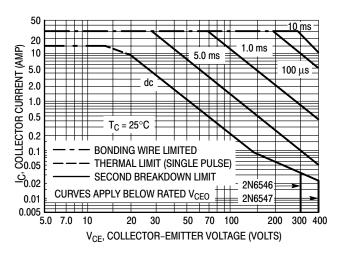


Figure 7. Forward Bias Safe Operating Area

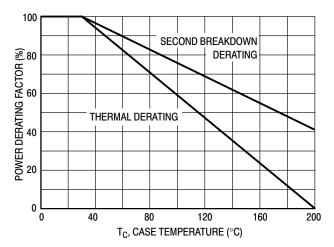


Figure 9. Power Derating

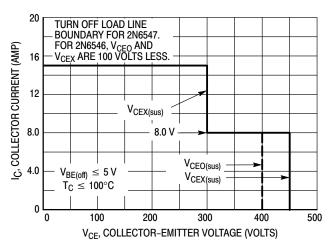


Figure 8. Reverse Bias Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C-V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 7 is based on $T_C = 25^{\circ}C$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \ge 25^{\circ}C$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 7 may be found at any case temperature by using the appropriate curve on Figure 9.

 $T_{J(pk)}$ may be calculated from the data in Figure 10. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

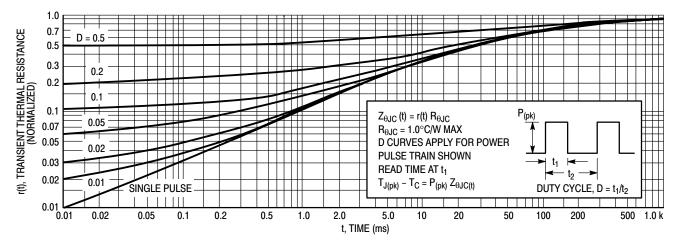
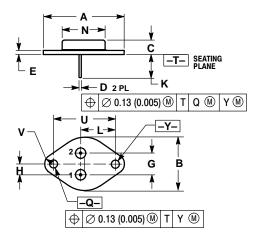


Figure 10. Thermal Response

PACKAGE DIMENSIONS

CASE 1-07 TO-204AA (TO-3) ISSUE Z



- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: INCH.

 3. ALL RULES AND NOTES ASSOCIATED WITH REFERENCED TO-204AA OUTLINE SHALL APPLY.

	INCHES		MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	1.550 REF		39.37	REF	
В		1.050		26.67	
C	0.250	0.335	6.35	8.51	
D	0.038	0.043	0.97	1.09	
Е	0.055	0.070	1.40	1.77	
G	0.430 BSC		10.92 BSC		
Н	0.215	BSC	5.46 BSC		
K	0.440	0.480	11.18	12.19	
L	0.665	BSC	16.89	BSC	
N		0.830		21.08	
Q	0.151	0.165	3.84	4.19	
U	1.187	BSC	30.15	BSC	
٧	0.131	0.188	3 33	4 77	

STYLE 1: PIN 1. BASE 2. EMITTER CASE: COLLECTOR

Notes

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